

On-State Current

Gate Trigger Current

0.8 Amp

 $< 200 \, \mu A$

Off-State Voltage

400 V ÷ 600 V

FEATURES

- Glass/passivated die junctions
- Low current SCR
- Low thermal resistance
- High surge current capability
- Low forward voltage drop
- Solder dip 260°C, 10s
- Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC
- Meets MSL level 3, per J-STD-020, LF maximum peak of 260° C

MECHANICAL DATA

- Case: (TO-92 / SOT-223 /SOT23-3L). Epoxy meets UL 94V-0 flammability rating.
- Polarity: As marked on the body.
- **Terminals:** Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.

TYPICAL APPLICATIONS

Thanks to highly sensitive triggering levels, the FS01xxxx SCR series is suitable for all applications where available gate current is limited, such as ground fault circuit interruptors, pilot circuits in solid state relays, stand-by mode power supplies, smoke and alarm detectors.

Maximun Ratings and Electrical Characteristics at 25°C

SYMBOL	PARAMETER	CONDITIONS	Value	Unit
I _{T(RMS)}	RMS On-state Current	180 ° Conduction Angle, T _c = 115 °C	0.8	А
I _{T(AV)}	Average On-state Current	180 ° Conduction Angle, T _c = 115 °C	0.5	А
I _{TSM}	Non-repetitive On-State Current	Half Cycle, 60 Hz	8	А
I _{TSM}	Non-repetitive On-State Current	Halfl Cycle, 50 Hz	7	А
l ² t	Fusing Current	tp = 10 ms, Half Cycle	0.24	A ² s
I _{GM}	Peak Gate Current	20 μs max. Tj = 125 ° C	1	А
$P_{G(AV)}$	Average Gate Power Dissipation	Tj = 125 ° C	0.1	W
T _j	Operating Temperature		(-40 to +125)	°C
T_{stg}	Storage Temperature		(-40 to +150)	°C
T _{sld}	Soldering Temperature	10s max.	260	°C

SYMBOL	PARAMETER	CONDITIONS	VOLTAGE		Unit
OTWIDOL	174740121214	CONDITIONS	D	М	
V_{DRM} V_{RRM}	Repetitive Peak Off State Voltage	R_{GK} = 1 k Ω	400	600	V

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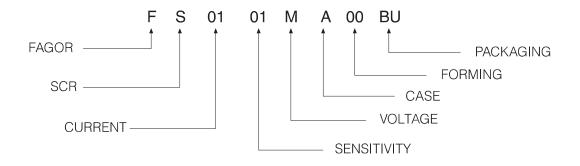
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Electrical Characteristics at Tamb = 25 °C

SYMBOL	DADAMETED	CONDITIONS		SENSITIVITY			Unit			
STIVIBUL	PARAMETER			01	02	03	04	18	Offile	
I _{GT}	Gate Trigger Current	$V_D = 12 V_{DC}$, $R_L = 140 \Omega$	2 . $T_j = 25 ^{\circ}\text{C}$	MIN MAX	1 20	200	20 200	15 50	0.5 5	μΑ
V_{GT}	Gate Trigger Voltage	$V_{\rm D} = 12 V_{\rm DC}$, $R_{\rm L} = 140 \Omega$	•	MAX			0.8	'		V
V_{GD}	Gate Non Trigger Voltage	$V_D = V_{DRM}$, $R_L = 3.3 k\Omega$, $T_j = 125 ^{\circ}C$	$R_{GK} = 220\Omega$	MIN			0.1			V
V_{RGM}	Reverse Gate Voltage	$I_{RG} = 10\mu A$,		MIN			8			V
I _H	Holding Current	$I_T=50~\text{mA},R_\text{GK}=1\text{k}\Omega$	$T_j = 25$ °C	MAX			5			mA
IL	Latching Current	$I_G = 1 \text{ mA}, R_{GK} = 1 \text{ k}\Omega$		MAX			6			mA
dV / dt	Critical Rate of Voltage Rise	$V_D = 0.67 \text{ x } V_{DRM}$, $R_{GK} = T_j = 125 ^{\circ}\text{C}$	1 k Ω ,	MIN	80	75	80	80	80	V/µs
dI / dt	Critical Rate of Current Rise	$I_G = 2 \times I_{GT}$ tr $\leq 100 \text{ ns}$, $T_j = 125 ^{\circ}\text{C}$	f = 60 Hz,	MIN			50			A/µs
V_{TM}	On-state Voltage	at $I_T = 1.6$ Amp, $tp = 380$	μ s, $T_j = 25$ °C	MAX			1.95	5		V
V _{t 0}	Threshold Voltage	T _j = 125 °C		MAX			0.95	5		V
r _d	Dynamic resistance	$T_j = 125$ °C		MAX			600			$m\Omega$
I _{DRM} / I _{RRM}	Off-State Leakage Current	$\begin{aligned} V_D &= V_{DRM}, \ R_{GK} = 1 k \Omega \\ V_R &= V_{RRM}, \end{aligned}$	$T_j = 125 ^{\circ}\text{C}$ $T_j = 25 ^{\circ}\text{C}$	MAX MAX			100 1			μΑ μΑ
$R_{\text{th(j-c)}}$	Thermal Resistance Junction-Case for DC		TO-92 SOT-223				80 30			°C/W
D	Thermal Resistance Junction-Amb for DC	Mounted on recomender Pad Layout	ed SOT23-3L				400			°C/W
$R_{th(j-a)}$			TO-92				150			°C/W
		$S = 5 cm^2$	SOT-223				60			°C/W

Part Number Information





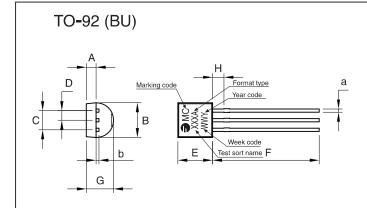
Ordering information

PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FS0102DA 00AM	AM	AMMO	2,000	0.2
FS0102DA 00BU	BU	BULK	10,000	0.2

PREFERRED P/N PACKAGE CODE		DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FS0102DN 00RS	RS	REEL	1,000	0.116
FS0102DN 00RB	RB	REEL	2,500	0.116

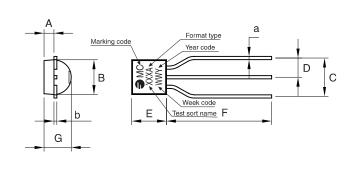
PREFERRED P/N	PACKAGE CODE	DELIVERY MODE	BASE QUANTITY	UNIT WEIGHT (g)
FS0102DL 00RB	RB	REEL	3,000	0.01

Package Outline Dimensions: (mm) TO-92



	DIMENSIONS					
REF.	Milimeters					
	Min.	Тур.	Max.			
Α	0.90	1.20	1.50			
В	4.40	4.60	4.80			
С	2.34	2.54	2.74			
D	1.07	1.27	1.47			
E	4.40	4.60	4.80			
F	12.70	14.10	15.50			
G	3.40	3.60	3.86			
Н	1.30	1.50	1.70			
а	0.38	0.44	0.51			
b	0.33	0.41	0.51			

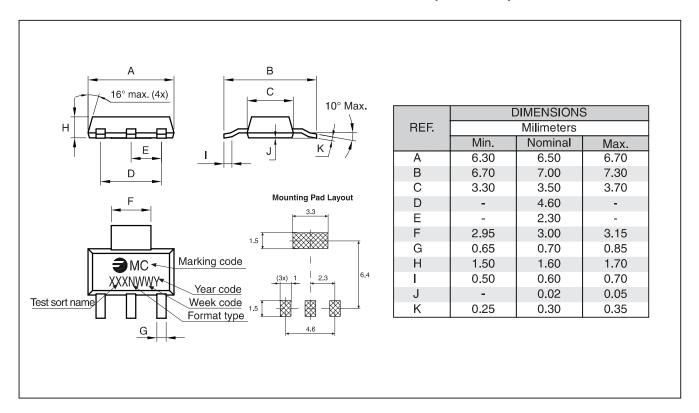
TO-92 (AMMO)



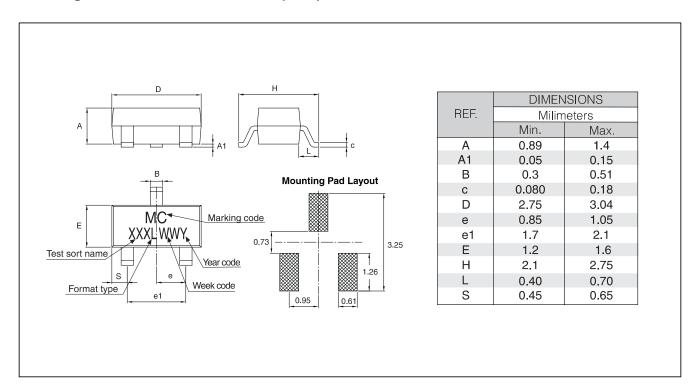
			0		
	DIMENSIONS				
REF.	Milimeters				
	Min.	Тур.	Max.		
Α	0.90	1.20	1.50		
В	4.40	4.60	4.80		
С	4.96	5.08	5.20		
D	2.42	2.54	2.66		
E	4.40	4.60	4.80		
F	12.30	13.70	15.50		
G	3.40	3.60	3.86		
Н	1.30	1.50	1.70		
а	0.38	0.44	0.51		
b	0.33	0.41	0.51		



Package Outline Dimensions: (mm) TO-261AA (SOT-223)



Package Outline Dimensions: (mm) SOT23-3L



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Ratings and Characteristics (Ta 25 °C unless otherwise noted)

Fig. 1: Maximum average power dissipation versus average on-state current

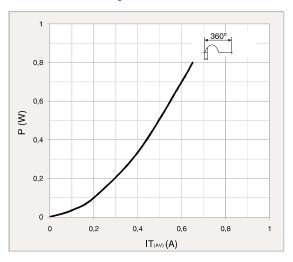


Fig. 3: Relative variation of thermal impedance junction to ambient verus pulse duration

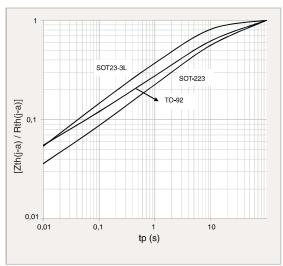


Fig. 5: Relative variation of holding current versus gate-cathode resistance (Typical values)

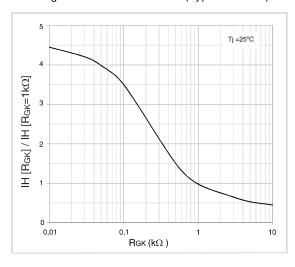


Fig. 2: Average and D.C. on-state current versus ambient temperature

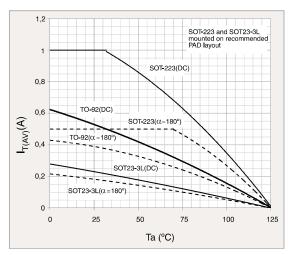


Fig. 4: Relative variation of gate trigger, holding and latching current versus junction temperature (Typical values)

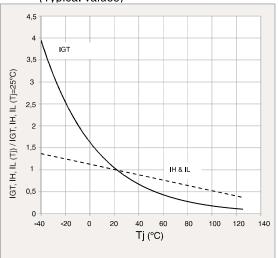


Fig. 6: Relative variation of dV/dt immunity versus gate-cathode resistance (Typical values)

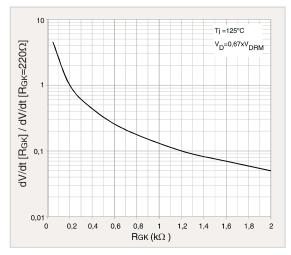




Fig. 7: Relative variation of dV/dt immunity versus gate-cathode capacitance (Typical values)

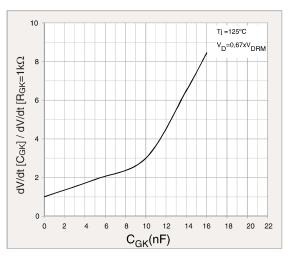


Fig. 9: Non repetitive surge peak on-state current and corresponding value of $\, I^2 \, t \,$

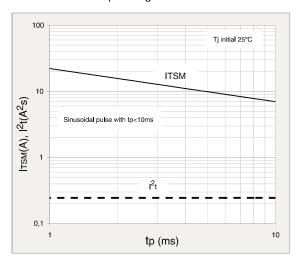


Fig. 8: Non repetitive surge peak on-state current versus number of cycles

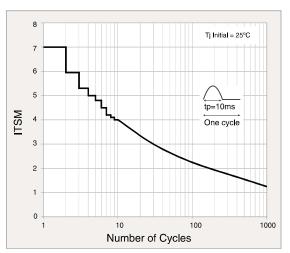
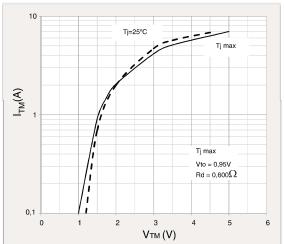


Fig.10 On-state characteristics (Maximum values)





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